



Description

This two-bit non-inverting translator which is a bidirectional voltage-level translator and can be used to build digital switching compatibility between multi voltage systems. This IC uses two separate configurable power supply tracks that including A ports supporting operating voltages from 1.65 V to 3.6 V with tracking V_{CCA} supply, and also including B ports supporting operating voltages from 2.3 V to 5.5V with tracking V_{CCB} supply.

The advantage above provides the support of both lower and higher logic signal levels while providing bidirectional translation capabilities between any of the 1.8V,2.5V,3.3V,and 5V voltage circuit points. Placing output-enable(OE) input to low level,all I/Os are forced to high-impedance state that significantly lower the quiescent current consumption. In order to ensure the high-impedance state during power up or power down, OE pin should be tied to GND via a pulldown resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

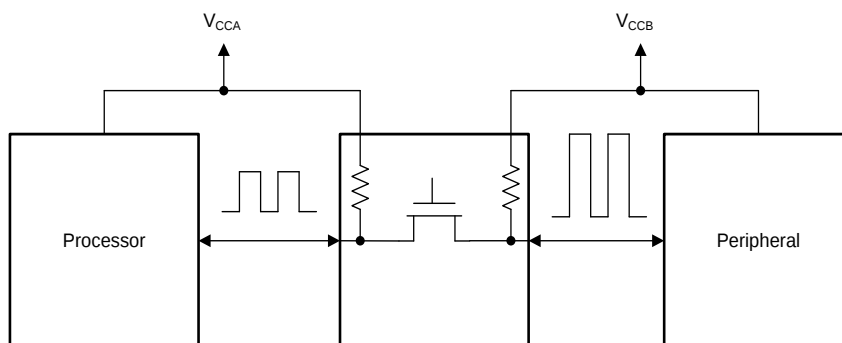
Features

- No direction-control
- Data rates
24 Mbps (Push Pull)
2 Mbps (Open Drain)
- 1.65V to 3.6V on A port and 2.3V to 5.5V on B port ($V_{CCA} \leq V_{CCB}$)
- VCC isolation feature:If either VCC input is at GND,both ports are in the high-impedance state
- No power-supply sequencing required:
either V_{CCA} or V_{CCB} can be ramped first
- IOFF supports partial-power-down mode operation
- Operating temperature range:-40°C to +85°C

Applications

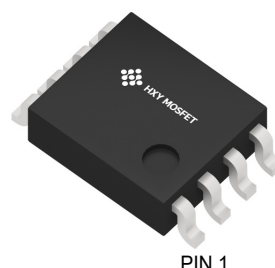
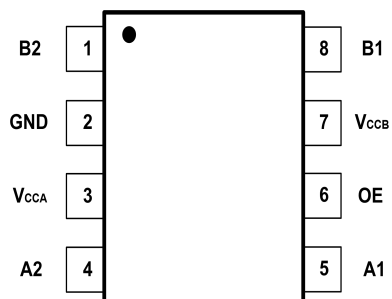
- Handset/Smartphone
- MART
- IPC
- GPIO

Circuit Diagram





Pin Assignment



TXS0102DCUR (VSSOP-8) Package

Device Summary, Pin and Packages (Continued)

Pin		I/O	Function
Name	DCUR		
VCCB	7	-	B Port Supply Voltage. $2.3V \leq V_{CCB} \leq 5.5V$
B1	8	I/O	Input/Output B1. Referenced to VCCB.
B2	1	I/O	Input/Output B2. Referenced to VCCB.
OE	6	I	Output Enable (Active High). Pull OE low to place all outputs in 3-state mode. Referenced to VCCA.
GND	2	-	Ground
A2	4	I/O	Input/Output A2. Referenced to VCCA.
A1	5	I/O	Input/Output A1. Referenced to VCCA.
VCCA	3	-	A Port Supply Voltage. $1.65V \leq V_{CCA} \leq 3.6V$ and $V_{CCA} \leq V_{CCB}$.

*It is suggested to leave the unconnected pins floating.



Order Information

Package	Orderable Device	PackingQty	Body Size
VSSOP-8	TXS0102DCUR	Tape and Reel,3000	2.00mm x 2.30mm

Absolute Maximum Ratings

Parameters		Min	Max	Unit
Supply voltage, V_{CCA}		-0.3	6.0	V
Supply voltage, V_{CCB}		-0.3	6.0	V
Input voltage range, V_I	A port	-0.3	6.0	V
	B port	-0.3	6.0	
Voltage range applied to any output in the high-impedance or power-off state, V_O	A port	-0.3	6.0	V
	B port	-0.3	6.0	
Voltage range applied to any output in the high or low state, V_O	A port	-0.3	$V_{CCA}+0.3$	V
	B port	-0.3	$V_{CCB}+0.3$	
Input clamp current, I_{IK}	$V_I < 0$		-50	mA
Output clamp current, I_{OK}	$V_O < 0$		-50	mA
Continuous output current, I_O			± 50	mA
Continuous current through V_{CCA} , V_{CCB} or GND			± 100	mA
Maximum junction temperature			150	°C
Storage temperature range		-65	150	°C

(1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

(2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

(3) The value of V_{CCA} and V_{CCB} are provided in the recommended operating conditions table.

ESD Ratings

ESD			Value	Unit
V(ESD)	Electrostatic Discharge	Human-Body Model (HBM) ⁽¹⁾	$\pm 5K$	V
		Charged-Device Model (CDM) ⁽²⁾	$\pm 2K$	V

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.



Recommended Operating Conditions

V_{CCI} is the supply voltage associated with the input port. V_{CCO} is the supply Voltage associated with the output port.

Parameter	Conditions		Min	Typ	Max	Unit
Supply voltage ⁽¹⁾	V_{CCA}		1.65		3.6	V
	V_{CCB}		2.3		5.5	
High-level input voltage(V_{IH})	A-port I/Os	$V_{CCA}=1.65\text{ V to }1.95\text{ V}$ $V_{CCB}=2.3\text{ V to }5.5\text{ V}$	$V_{CCI}-0.2$		V_{CCI}	V
		$V_{CCA}=2.3\text{ V to }3.6\text{ V}$ $V_{CCB}=2.3\text{ V to }5.5\text{ V}$	$V_{CCI}-0.4$		V_{CCI}	
	B-port I/Os	$V_{CCA}=1.65\text{ V to }3.6\text{ V}$ $V_{CCB}=2.3\text{ V to }5.5\text{ V}$	$V_{CCI}-0.4$		V_{CCI}	
	OE input	$V_{CCA}=1.65\text{ V to }3.6\text{ V}$ $V_{CCB}=2.3\text{ V to }5.5\text{ V}$	$V_{CCI} \times 0.8$		5.5	
Low-level input voltage(V_{IL}) ⁽²⁾	A-port I/Os	$V_{CCA}=1.65\text{ V to }1.95\text{ V}$ $V_{CCB}=2.3\text{ V to }5.5\text{ V}$	0		0.15	V
	B-port I/Os	$V_{CCA}=1.65\text{ V to }3.6\text{ V}$ $V_{CCB}=2.3\text{ V to }5.5\text{ V}$	0		0.15	
OE	OE input	$V_{CCA}=1.65\text{ V to }3.6\text{ V}$ $V_{CCB}=2.3\text{ V to }5.5\text{ V}$	0		$V_{CCA} \times 0.25$	V
Input transition rise or fall rate($\Delta t/\Delta v$)	A-port I/Os push-pull driving				10	ns/V
	B-port I/Os push-pull driving				10	
	Control input				10	
TA Operating free-air temperature	-		-40		85	°C

(1) V_{CCA} must be less than or equal to V_{CCB} .

(2) The maximum V_{IL} value is provided to ensure that a valid V_{OL} is maintained. The V_{OL} value is V_{IL} plus the voltage drop across the pass gate transistor.



Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted) ⁽¹⁾ ⁽²⁾ ⁽³⁾

Parameter		Conditions	V _{CCA}	V _{CCB}	Temp	Min	Typ	Max	Unit
V _{OHA}	Port A Output High Voltage	I _{OH} =-20 μ A V _{IB} $\geq$ V _{CCB} - 0.4V	1.65V to 3.6V	2.3V to 5.5V	Full	V _{CCA} $\times$ 0.7			V
V _{OLA}	Port A Output Low Voltage	I _{OL} =1mA V _{IB} $\leq$ 0.15 V	1.65V to 3.6V	2.3V to 5.5V	Full			0.3	V
V _{OHB}	Port B Output High Voltage	I _{OH} =-20 μ A V _{IA} $\geq$ V _{CCA} - 0.4V	1.65V to 3.6V	2.3V to 5.5V	Full	V _{CCA} $\times$ 0.7			V
V _{OLB}	Port B Output Low Voltage	I _{OL} =1mA V _{IA} $\leq$ 0.15 V	1.65V to 3.6V	2.3V to 5.5V	Full			0.3	V
I _I	Input Leakage Current	OE	1.65V to 3.6V	2.3V to 5.5V	+25°C			$\pm$ 1	μ A
					Full			$\pm$ 1.5	
I _{off}	Partial Power Down Current	A Ports	0V	0V to 5.5V	+25°C			$\pm$ 0.5	μ A
					Full			$\pm$ 1	
		B Ports	0V to 3.6V	0V	+25°C			$\pm$ 0.5	
					Full			$\pm$ 1	
I _{OZ}	High-impedance State Output Current	A or B port OE=0V	1.65V to 3.6V	2.3V to 5.5V	+25°C			$\pm$ 0.5	μ A
					Full			$\pm$ 1	
I _{CCA}	V _{CCA} Supply Current	V _I =V _O =open I _O =0	1.65V to V _{CCB}	2.3v to 5.5V	Full			2.5	μ A
			3.6v	0V	Full			2.5	
			0v	5.5V	Full			-1	
I _{CCB}	V _{CCB} Supply Current	V _I =V _O =open I _O =0	1.65V to V _{CCB}	2.3v to 5.5V	Full			10	μ A
			3.6v	0V	Full			-1	
			0v	5.5V	Full			1	
I _{CCA} + I _{CCB}	Combined Supply Current	V _I =V _{CCI} or GND I _O =0	1.65V to V _{CCB}	2.3v to 5.5V	Full			13	μ A
I _{CCZA}	V _{CCA} Supply Current	V _I =V _{CCI} or 0V I _O =0, OE=0V	1.65V to V _{CCB}	2.3v to 5.5V	Full			1	μ A
I _{CCZB}	V _{CCB} Supply Current	V _I =V _{CCI} or 0V I _O =0, OE=0V	2.3v to 3.6V	2.3v to 5.5V	Full			1	μ A
C _i	Input Capacitance	OE	3.3V	3.3V	+25°C		2.5		PF
C _o	Input-to-output Internal Capacitance	A Port	3.3V	3.3V	+25°C		5		PF
		B Port	3.3V	3.3V	+25°C		5		

(1) V_{CCI} is the VCC associated with the input port.

(2) V_{CCO} is the VCC associated with the output port

(3) V_{CCA} must be less than or equal to V_{CCB}.



Timing Requirements

$V_{CCA}=1.8V\pm0.15V$

		$V_{CCB}=2.5V\pm0.2V$	$V_{CCB}=3.3V\pm0.2V$	$V_{CCB}=5V\pm0.2V$	Unit
		Typ	Typ	Typ	
Data Rate	Push-pull Driving	21	22	24	Mbps
	Open-drain Driving	2	2	2	
Pulse Duration(tw)	Push-pull Driving (Data Inputs)	47	45	41	ns
	Open-drain Driving (Data Inputs)	500	500	500	

$V_{CCA}=2.5V\pm0.15V$

		$V_{CCB}=2.5V\pm0.2V$	$V_{CCB}=3.3V\pm0.2V$	$V_{CCB}=5V\pm0.2V$	Unit
		Typ	Typ	Typ	
Data Rate	Push-pull Driving	20	22	24	Mbps
	Open-drain Driving	2	2	2	
Pulse Duration(tw)	Push-pull Driving (Data Inputs)	50	45	41	ns
	Open-drain Driving (Data Inputs)	500	500	500	

$V_{CCA}=3.3V\pm0.15V$

		$V_{CCB}=3.3V\pm0.2V$	$V_{CCB}=5V\pm0.2V$	Unit
		Typ	Typ	
Data Rate	Push-pull Driving	23	24	Mbps
	Open-drain Driving	2	2	
Pulse Duration(tw)	Push-pull Driving (Data Inputs)	43	41	ns
	Open-drain Driving (Data Inputs)	500	500	



Switching Characteristics: $V_{CC}=1.8V\pm0.15V$

over recommended operating free-air temperature range (unless otherwise noted)

Parameter		Conditions		$V_{CCB}=2.5V\pm0.2V$	$V_{CCB}=3.3V\pm0.2V$	$V_{CCB}=5V\pm0.2V$	Units
				Typ	Typ	Typ	
t_{PHL}	Propagation Delay Time High-to-low Output	A to B	Push-pull Driving	5.6	5	5	ns
			Open-drain Driving	7.5	7.9	8.3	
t_{PLH}	Propagation Delay Time low-to-high Output	A to B	Push-pull Driving	10.0	9.5	9	ns
			Open-drain Driving	181	170	154	
t_{PHL}	Propagation Delay Time High-to-low Output	B to A	Push-pull Driving	7	7.1	7.2	ns
			Open-drain Driving	7.6	8.1	9.2	
t_{PLH}	Propagation Delay Time low-to-high Output	B to A	Push-pull Driving	7.6	6.9	6	ns
			Open-drain Driving	163	145	118	
t_{en}	Enable Time	OE to A or B		135	159	182	ns
t_{dis}	Disable Time	OE to A or B		170	174	181	ns
t_{rA}	Input Rise Time	A port rise time	Push-pull Driving	13.4	11.9	10.6	ns
			Open-drain Driving	68	66	62	
t_{rB}	Input Rise Time	B port rise time	Push-pull Driving	13	12	11.6	ns
			Open-drain Driving	66	65	50	
t_{fA}	Input Fall Time	A port fall time	Push-pull Driving	5.6	4.7	4.0	ns
			Open-drain Driving	5.0	5.1	5.2	
t_{fB}	Input Fall Time	B port fall time	Push-pull Driving	3.0	3.0	2.9	ns
			Open-drain Driving	6.1	5.6	4.4	
$t_{SK(O)}$	Skew(time), Output	Channel-to-Channel Skew		0.5	0.5	0.5	ns
Maximum Data Rate		Push-pull Driving		22	23	24	Mbps
		Open-drain Driving		2	2	2	



Switching Characteristics: $V_{CC}=2.5V\pm0.15V$

over operating free-air temperature range (unless otherwise noted)

Parameter		Conditions		$V_{CCB}=2.5V\pm0.2V$	$V_{CCB}=3.3V\pm0.2V$	$V_{CCB}=5V\pm0.2V$	Units
				Typ	Typ	Typ	
t_{PHL}	Propagation Delay Time High-to-low Output	A to B	Push-pull Driving	3.5	3.5	3.2	ns
			Open-drain Driving	6.3	6.5	6.7	
t_{PLH}	Propagation Delay Time low-to-high Output	A to B	Push-pull Driving	4.5	4.9	4.7	ns
			Open-drain Driving	158	152	142	
t_{PHL}	Propagation Delay Time High-to-low Output	B to A	Push-pull Driving	3.7	3.9	4.6	ns
			Open-drain Driving	6	6.6	7.7	
t_{PLH}	Propagation Delay Time low-to-high Output	B to A	Push-pull Driving	4.8	4	2.5	ns
			Open-drain Driving	153	138	116	
t_{en}	Enable Time	OE to A or B		7.7	41.8	130	ns
t_{dis}	Disable Time	OE to A or B		175	181	182	ns
t_{rA}	Input Rise Time	A port Rise Time	Push-pull Driving	9.8	8.6	7.5	ns
			Open-drain Driving	79	77	65	
t_{rB}	Input Rise Time	B port Rise Time	Push-pull Driving	9.8	8.7	8.1	ns
			Open-drain Driving	93	68	53	
t_{fA}	Input Fall Time	A port Fall Time	Push-pull Driving	4.6	4.1	3.6	ns
			Open-drain Driving	5.1	5.1	5.2	
t_{fB}	Input Fall Time	B port Fall Time	Push-pull Driving	4.5	4.0	4.0	ns
			Open-drain Driving	6.9	7.4	7.8	
$t_{SK(O)}$	Skew(time), Output	Channel-to-Channel Skew		0.5	0.5	0.5	ns
Maximum Data Rate		Push-pull Driving		22	24	24	Mbps
		Open-drain Driving		2	2	2	



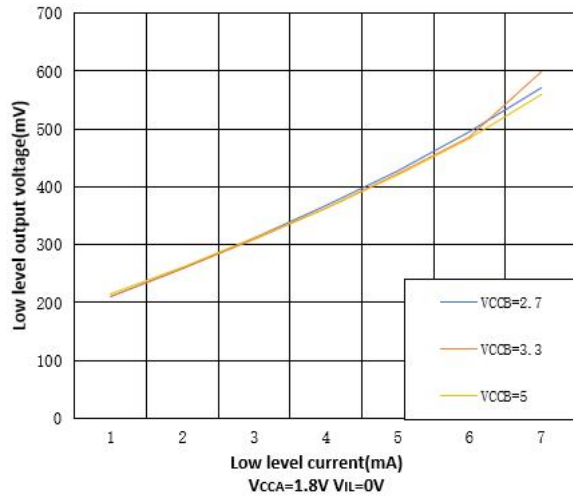
Switching Characteristics: $V_{CC}=3.3V\pm0.15V$

over recommended operating free-air temperature range (unless otherwise noted)

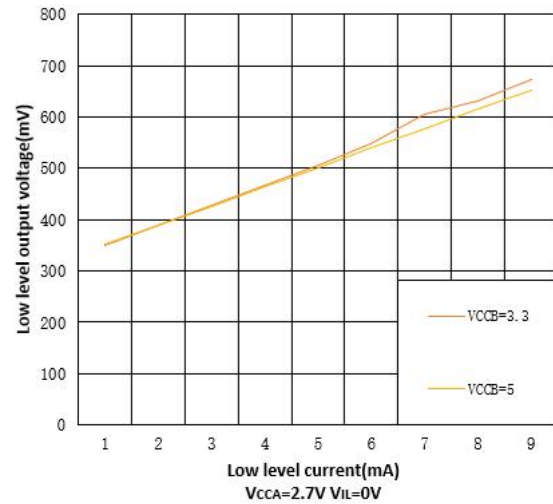
Parameter		Conditions		$V_{CCB}=3.3V\pm0.2V$	$V_{CCB}=5V\pm0.2V$	Units
				TYP	TYP	
t_{PHL}	Propagation Delay Time High-to-low Output	A to B	Push-pull Driving	2.1	2.2	ns
			Open-drain Driving	5.9	6.1	
t_{PLH}	Propagation Delay Time High-to-low Output	A to B	Push-pull Driving	1	3.3	ns
			Open-drain Driving	138	131	
t_{PHL}	Propagation Delay Time High-to-low Output	B to A	Push-pull Driving	2.3	2.6	ns
			Open-drain Driving	5.4	6.6	
t_{PLH}	Propagation delay time low-to-high Output	B to A	Push-pull Driving	1.0	1.0	ns
			Open-drain Driving	133	115	
t_{en}	Enable Time	OE to A or B		4.7	5.2	ns
t_{dis}	Disable Time	OE to A or B		174	182	ns
t_{rA}	Input Rise Time	A port Rise Time	Push-pull Driving	7.4	6.6	ns
			Open-drain Driving	75	67	
t_{rB}	Input Rise Time	B port Rise Time	Push-pull Driving	7.7	7.1	ns
			Open-drain Driving	70	65	
t_{fA}	Input Fall Time	A port Fall Time	Push-pull Driving	3.4	3.0	ns
			Open-drain Driving	5.1	5.1	
t_{fB}	Input Fall Time	B port Fall Time	Push-pull Driving	3.5	3.2	ns
			Open-drain Driving	6.8	6.7	
$t_{SK(O)}$	Skew(time), Output	Channel-to-Channel Skew		0.5	0.5	ns
Maximum Data Rate		Push-pull Driving		24	24	Mbps
		Open-drain Driving		2	2	



Typical Characteristics



Low Level Output Voltage vs Low Level Current



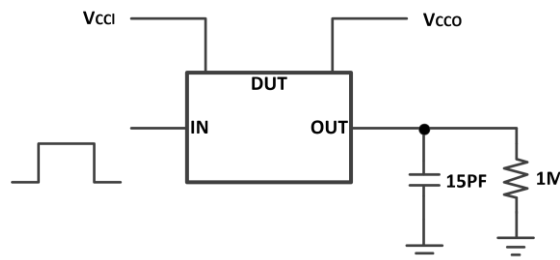
Low Level Output Voltage vs Low Level Current

Parameter Measurement Information

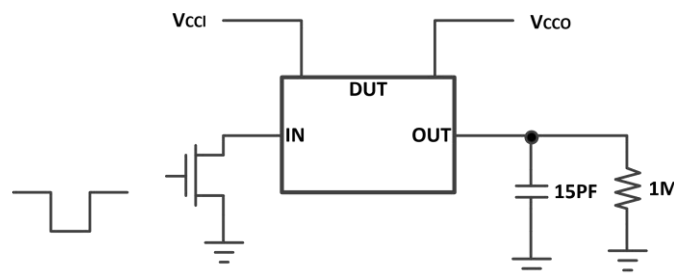
Unless otherwise noted, all input pulsed are supplied by generators having the following characteristics:

- PSRR 10MHz
- $Z_o=50\ \Omega$
- $dv/dt \geq 1V/ns$

Note: All input pulses are measured one at a time with one transition per measurement



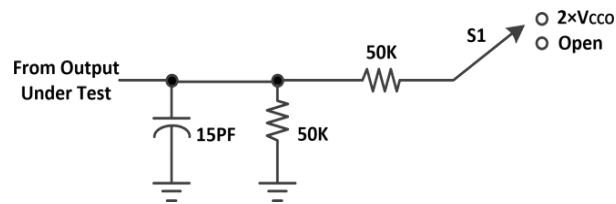
Data Rate, Pulse Duration, Propagation Delay, Output Rise and Fall Time Measurement Using a Push-Pull Driver



Data Rate, Pulse Duration, Propagation Delay, Output Rise and Fall Time Measurement Using an Open-Drain Driver



Parameter Measurement Information (Continued)



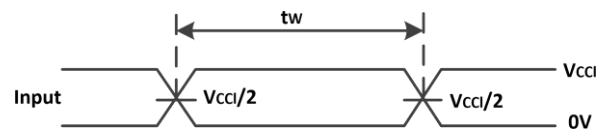
Load Circuit for Enable/Disable Time Measurement

Switch Configuration for Enable/Disable Timing

Test	S1
$t_{PZL}^{(1)}$, $t_{PLZ}^{(2)}$	$2 \times V_{CCO}$
$t_{PHZL}^{(1)}$, $t_{PZH}^{(2)}$	Open

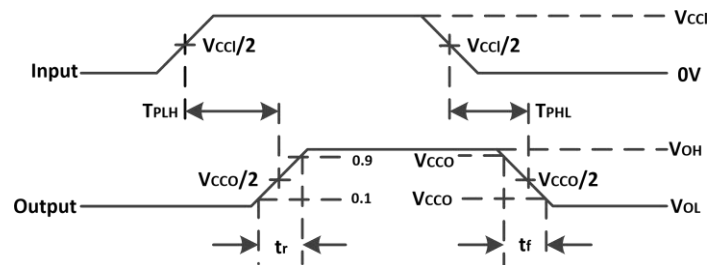
(1) t_{PZL} and t_{PZH} are the same as t_{en} .

(2) t_{PLZ} and t_{PHZ} are the same as t_{dis} .

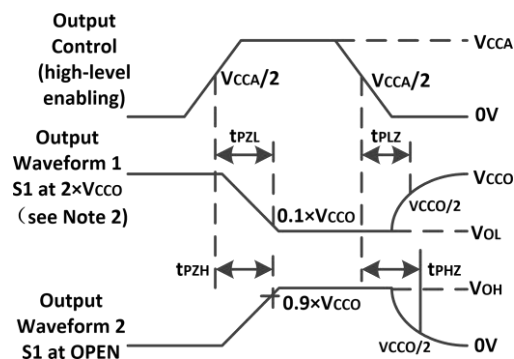


(1) All input pulses are measured one at a time, with one transition per measurement.

Voltage Waveforms Pulse Duration



Voltage Waveforms Propagation Delay Times



Voltage Waveforms Enable and Disable

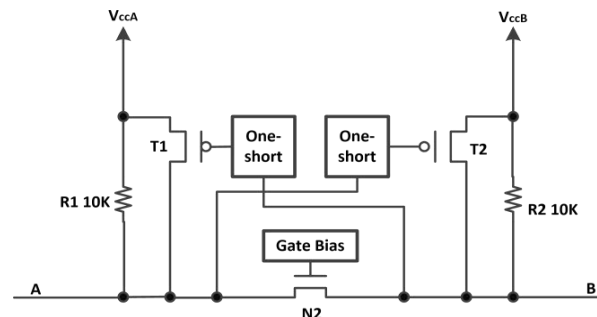


Overview

The TXS0102DCUR IC is a Bi-direction voltage-level translator specifically designed for translating logic voltage levels. The A port can accept I/O voltages that cover from 1.65 V to 3.6 V range; The B port can accept I/O voltages from 2.3 V to 5.5 V. The device is a pass-gate architecture with edge-rate accelerators (one-shots) to improve the overall data rate. 10-k Ω pullup resistors that usually used in open-drain applications have been integrated inside IC with the advantage saving an external resistor. Not only the IC is designed for open-drain applications, but also this device can translate push-pull CMOS logic outputs.

Architecture

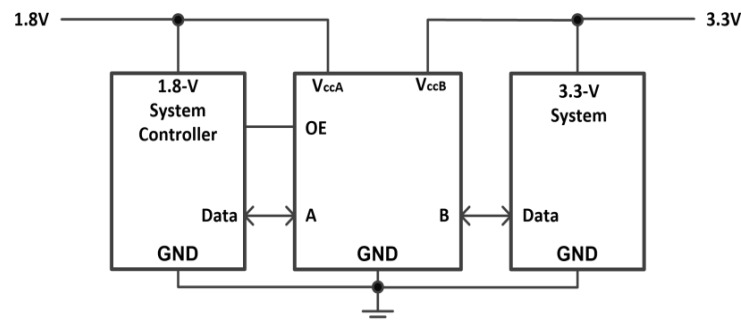
The TXS0102DCUR architecture (see Figure below) is a translator with Bi-direction-Sensing function that means a direction-control mechanism to control the direction of data flow from A to B or from B to A is not needed. These two bidirectional channels independently determine the direction of data flow without a direction-control signal. This auto-direction feature is realized by each I/O pin can be automatically reconfigured as either an input or an output.



Architecture of TXS0102DCUR

Application Information

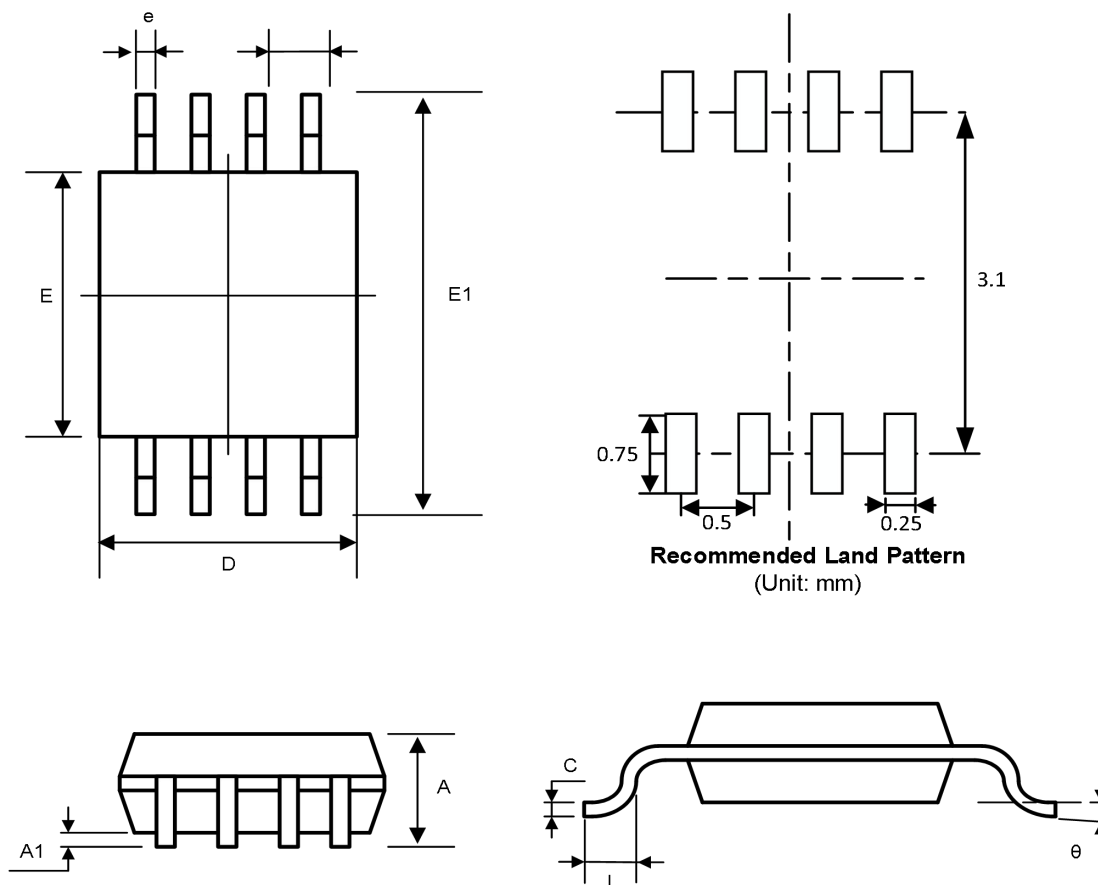
The TXS0102DCUR device can be used to bridge the digital-switching compatibility gap between two voltage nodes to successfully interface logic threshold levels found in electronic systems. It should be used in a point-to-point topology for interfacing devices or systems operating at different interface voltages with one another. Its primary target application use is for interfacing with open-drain drivers on the data I/Os such as I2C or 1-wire, where the data is bidirectional and no control signal is available. The device can also be used in applications where a push-pull driver is connected to the data I/Os, but the WTXS0108E might be a better option for such push-pull applications.



Typical Application Schematic



Package Outline Dimensions
VSSOP-8-0.9mm



Symbol	Dimensions in Millimeters		Dimensions in Inches	
	Min	Max	Min	Max
A	0.600	0.900	0.024	0.085
A1	0.000	0.100	0.000	0.004
b	0.170	0.250	0.007	0.010
c	0.100	0.200	0.004	0.008
D	1.900	2.100	0.075	0.083
e	0.500(BSC)		0.020(BSC)	
E1	3.000	3.200	0.118	0.126
E	2.200	2.400	0.087	0.095
L	0.200	0.350	0.008	0.014
θ	0°	6°	0°	6°



Attention

- Any and all HUA XUAN YANG ELECTRONICS products described or contained herein do not have specifications that can handle applications that require extremely high levels of reliability, such as life-support systems, aircraft's control systems, or other applications whose failure can be reasonably expected to result in serious physical and/or material damage. Consult with your HUA XUAN YANG ELECTRONICS representative nearest you before using any HUA XUAN YANG ELECTRONICS products described or contained herein in such applications.
- HUA XUAN YANG ELECTRONICS assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all HUA XUAN YANG ELECTRONICS products described or contained herein.
- Specifications of any and all HUA XUAN YANG ELECTRONICS products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.
- HUA XUAN YANG ELECTRONICS CO.,LTD. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with some probability. It is possible that these probabilistic failures could give rise to accidents or events that could endanger human lives, that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.
- In the event that any or all HUA XUAN YANG ELECTRONICS products(including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from the authorities concerned in accordance with the above law.
- No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written permission of HUA XUAN YANG ELECTRONICS CO.,LTD.
- Information (including circuit diagrams and circuit parameters) herein is for example only ; it is not guaranteed for volume production. HUA XUAN YANG ELECTRONICS believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.
- Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. When designing equipment, refer to the "Delivery Specification" for the HUA XUAN YANG ELECTRONICS product that you intend to use.